



Image

AF  
2826

GR 97 P 1903

BOX AF

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450:

By:

Date: April 5, 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No. : 09/483,737 Confirmation No. 8769  
Applicant : Hansjörg Reichert et al.  
Filed : January 14, 2000  
TC/A.U. : 2826  
Examiner : Ahmed N Sefer  
Title: : Method and Apparatus for Producing a Chip-Substrate Connection  
  
Docket No. : GR 97 P 1903  
Customer No. : 24131

BOX AF

Hon. Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT under 37 C.F.R. § 1.116**

Sir:

In response to the final Office action dated January 7, 2004,  
please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 5 of this paper.